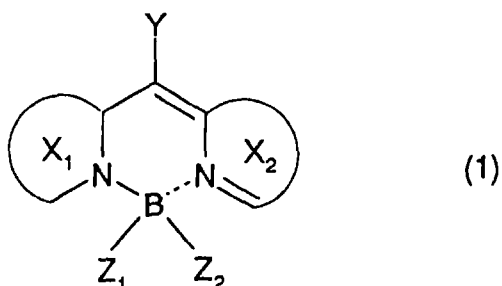




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ABSTRACT OF THE DISCLOSURE

A visible light curable resin composition is herein disclosed in which a dipyrromethene boron complex compound represented by the following formula (1) is used as a photosensitizer, and this composition has a very high sensitivity to a general-purpose visible light laser, so that a high-speed scanning exposure is possible by the laser, and an extremely fine high resolution can be obtained. In addition, the composition can be used for coating or printing under safelight irradiating conditions and under bright circumstantial conditions without any thickening of the composition, and hence the composition can exert excellent noticeable effects in points of safe operativity, operational efficiency, the quality stability of products:



wherein rings X_1 and X_2 are each an optionally substituted pyrrole ring; Y is H, CN, optionally substituted alkyl, aralkyl, aryl, heteroaryl or alkenyl group; and Z_1 and Z_2 are halogen, optionally substituted alkyl, alkoxy, alkylthio, aralkyl, aralkyloxy, aryl, aryloxy, arylthio, heteroaryl, heteroaryloxy or heteroarylthio group, provided that at



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least one of substituents on the pyrrole rings X_1 and X_2 , groups Z_1 and Z_2 is the alkoxy, aralkyloxy or aryloxy group.

(Figure 1)